

SmartBond[™] DA14583 IoT Sensor Development Kit The World's Lowest Power 12-DOF Wireless Sensor Module

The SmartBond IoT Sensor Development Kit makes developing motion and environmental sensing applications easy. Merging cutting-edge Bluetooth® low energy hardware, sensors and sensor fusion software, it enables the world's lowest power 12 degree-of-freedom (DOF) wireless sensor module. Highly integrated, it cuts system size and cost and includes all essential hardware and software to speed creation of advanced IoT devices.

This complete development platform helps you create environmental and/or motion sensing modules for wearable computing, immersive gaming, augmented reality, 3D indoor mapping/navigation and weather stations. Developed by Dialog Semiconductor on the basis of Bosch Sensortec sensors, it combines Bluetooth wireless communications and an ARM Cortex-M0 processor with an accelerometer, gyroscope, magnetometer



and environmental sensors. All this on a board measuring just 16 x 15 mm.

It also includes SmartFusion, Dialog's unique smart sensor fusion software library for data acquisition, sensor calibration and fusion. Ideal for resource-constrained systems, it minimizes memory, processing requirements and power consumption.

Applications

- ▶ Wearables
- ▶ Immersive gaming
- ► Augmented reality
- ▶ 3D indoor mapping / navigation
- ▶ Weather stations
- ► And other IoT sensor based applications

Benefits

- ► Lowest power consumption for a 12-DOF wireless sensor
- ► Faster time-to-market
- ► Reduced development effort and resources
- ▶ Ideal for resource-constrained applications
- ► Smaller-sized end products



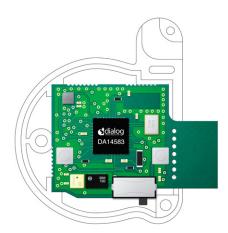




Accelerating your IoT Development

Key Features

- ► 12-DOF wireless sensor module development platform
 - DA14583 low-power Bluetooth low energy SoC
 - BMI160 6-axis inertial measurement unit
 - BMM150 3-axis geomagnetic field sensor
 - BME280 integrated environmental unit (pressure, temperature and humidity)
 - Smart sensor fusion software including auto-calibration
- ▶ Board size: 16 x 15 x 5 mm
- ► Stream fused quaternion orientation and/or sensor data via Bluetooth low energy interface
- ▶ User interface: IoT Sensors app (Android and iOS) that allows visualisation of sensor and orientation data as well as precise tuning and configuration.
- ▶ Performance for sensor fusion and streaming
 - Settings: 12.5 Hz Accelerometer; 25 Hz Gyroscope, 10 Hz Magnetometer, 0.5 Hz Environmental (Pressure, Temperature and Humidity)
 - Connected : < 1.3 mAAdvertising: < 110 μAPower save: < 11 μA



- ► Resource requirements for sensor fusion and auto-calibration:
 - Processor load:
 - 0.5 MIPS on Cortex M0 for combined magnetometer auto-calibration + 9 DOF sensor fusion (gyroscope and accelerometer at 100 Hz and magnetometer at 10 Hz)
 - Memory footprint:
 - 4.5 kB ROM code
 - 0.5 kB RAM

Dialog Semiconductor Worldwide Sales Offices - www.dialog-semiconductor.com smartbond@diasemi.com

 United Kingdom
 The Netherlands
 Japan
 Singapore

 Phone: +44 1793 757700
 Phone: +31 73 640 88 22
 Phone: +81 3 5425 4567
 Phone: +65 648 499 29

Germany North America Taiwan Hong Kong

Phone: +49 7021 805-0 Phone: +1 408 845 8500 Phone: +86 281 786 222 Phone: +852 3769 5200

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Phone: +82 2 3469 8200

China (Shenzhen)

Phone: +86 755 2981 3669

China (Shanghai)

Phone: +86 21 5424 9058

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